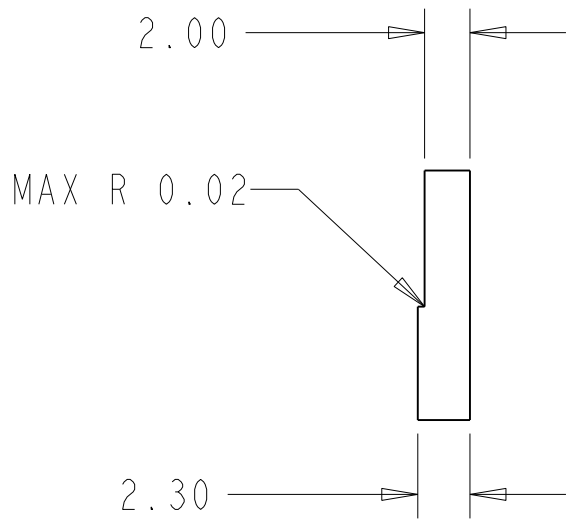
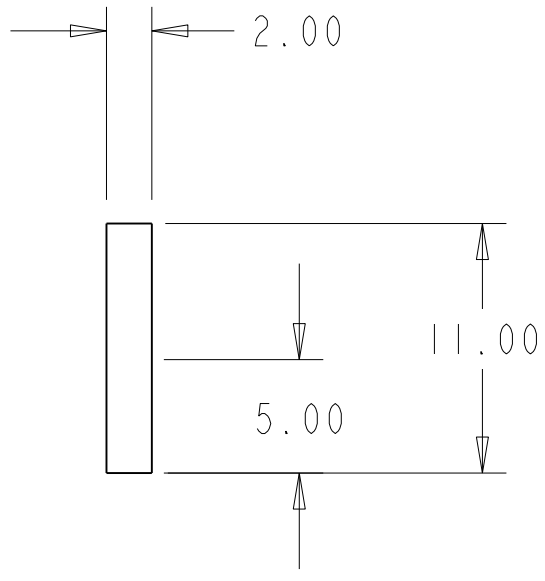
DWG. NO.	SIZE	REV.	SH.
21F3581		1	1





REV	DWG	CHK	DATE	CHANGES	DESCRIPTION	BFG 3D-CC MATERIAL

UNLESS OTHERWISE SPECIFIED

TOLERANCES: X.X ±0.1 | FRAC. ±1/64 | X.XX ±0.01 | Angles ±0.50° | X.XXX ±0.001 | FINISH 125 (µin)

DO NOT SCALE PRINT

THREADS ARE CLASS 2
CHAMFER ENDS OF ALL SCREW TREADS 30°
CUT ROUND, 1.5 THREAD RELIEF ON MACHINED THREADS
BREAK EDGES .016 MAX. ON MACHINED WORK
REMOVE BURRS, WELD SPLATTER & LOOSE SCALE
IN ACCORDANCE WITH ASME Y14.5M & B46.1

SHOP ORDERS

ACCT NO.	SEE J.O.	NO. REQD	120
DEL TO	JS WIRTH		
SURFACE TREATMT			
IDENT METHOD	TAG		
PROJECT NUMBER	ATL-IP-ED-0036		
PROJECT NAME	US ATLAS SILICON SUBSYSTEM		
DWG BY	D UKEN	DATE	18-Feb-01
CHK BY	J WIRTH	DATE	29-JUN-01
APR BY	E ANDERSSEN	DATE	

SER NO. -
DATE ISSD -
DATE REQD -

ERNEST ORLANDO LAWRENCE BERKELEY NATIONAL LABORATORY
UNIVERSITY OF CALIFORNIA - BERKELEY

ATLAS PIXEL DETECTOR
DISK SECTOR, MODULE LOCAL SUPPORT
BEAM HARDPOINT, SECTOR FACING SUPPORT

MICROFILMED:	DWG. TYPE	SHOWN ON	SCALE: 3.000	DO NOT SCALE PRINTS
	PART	21f406	SHEET 1 OF 1	
PATENT CLEAR:	DESIGN ACCT. NO.	CATEGORY CODE	21F358	REV. 1
	P1AP11	AP6110		

Rev. 1/8/2001 ATLAS

Dwg. File: 21F358 Model File: 21F358